

Main Features

- Support Socket 1155 for 3rd./2nd. Generation Intel® Core™ i7/i5/i3, Celeron Processors
- 4 x DDR3 DIMM Socket up to 32 GB
- Support HDMI/DVI-I/DisplayPort dual displays
- 2 x Intel® GbE, 4 x SATA3.0/2.0, mSATA, 12 x USB3.0/2.0, 6 x COM, 8 x GPIO
- 1 x PCIe16, 1 x PCIe4, 1 x mPCIe, 2 x PCI (v2.3)
- Support AT/ATX mode by ATX Power Input

Product Overview

NEX 883 is an industrial motherboard with Micro-ATX form factor, which support 3rd and 2nd Generation Intel® Core™ i7/i5/i3 and Celeron® processors. NEX 883 support dual channel DDR3 1600/1333/1066MHz memory in four long DIMM slots up to 32GB system memory and PCIe16 (3.0/2.0 by CPU)

The Q77 PCH support multiple displays by three DDI (digital display interfaces) for HDMI/DVI-I (VGA)/DP (shared LVDS) ports. Intel® Q77 PCH manages up to 2 x SATA 3.0/2 x SATA 2.0 with software RAID 0/1/5/10 supported and performs up to 12 x USB (4 x USB3.0/8 x USB2.0) ports. NEX 883 support PCIe4, mPCIe, legacy 2 x PCI slots, dual Intel® GbE ports and up to 6 x Series ports incl. 2 x RS-232/422/485 pre-selected in BIOS setting. NEX 883 could be integrated into 1U/2U/4U rack mounted chassis or Desktop Tower as completed system solution for widely industrial applications in the new era of digital infrastructure with NEXCOM.

Specifications

CPU Support

- Socket LGA1155, 3rd or 2nd Generation Intel® Core™ i7/i5/i3, Celeron® processors

Main Memory

- 4 x 240-pin dual channel long DIMMs support DDR3 1066/1333/1600Mhz up to 32GB system memory

Chipset

- Intel® Q77 Platform Controller Hub

BIOS

- AMI BIOS UEFI
- Plug and play support

On-board LAN

- 1 x Intel® 82579V/LM PHY for AMT 8.0
- 1 x Intel® 82583V PCI Express Gigabit Ethernet
- Support boot from LAN (PXE)
- 2 x RJ45 with LED

Display

- 3rd or 2nd Generation Intel® Core™ socket LGA1155 processors Integrated HD graphics 1 x VGA
- 1 x HDMI
- 1 x DVI-I

- 1 x DisplayPort

Expansion

- 1 x PCIe16 (Gen. 3.0/2.0 by CPU)
- 1 x PCIe4
- 2 x PCI (v2.3)

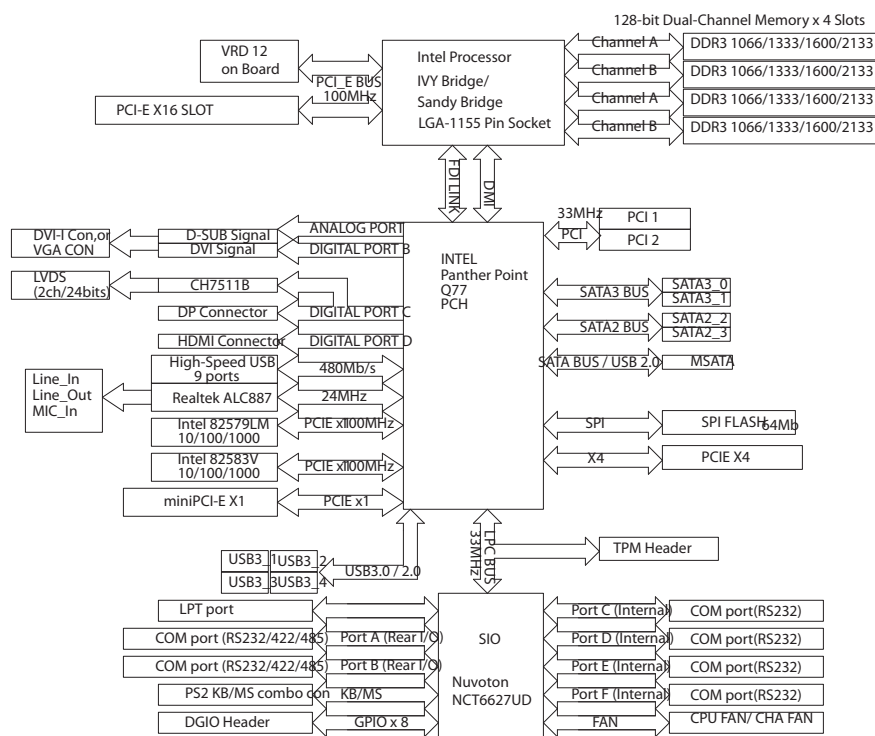
Edge I/O Interfaces

- 1 x Combo for PS2 KB/MS
- 2 x stack DB9 for COM1 & COM2
- 1 x HDMI with dual stack USB2.0 (black)
- 1 x DVI-I
- 2 x RJ45 with dual stack USB3.0 (blue) and dual stack USB2.0 (black) connectors
- Line-In/Line-out/MIC phone jack

I/O Interface

- USB3.0: 4 ports (2 x USB3.0 on edge I/O, 2 x internal box-header)
- USB2.0: 8 ports (4 x USB2.0 on edge I/O, 4 x internal box-header)
- Serial: 6 ports (default 2 x RS232 pre-selected RS422/485 in BIOS, 4 x RS232 by internal pins-header)
- SATA HDD: 4 ports, port 0, 1 support SATA 3.0, port 2, 3 support SATA 2.0, dual SATA Power by 2 x 4Pins
- Support Software RAID 0/1/5/10 and Intel® Matrix Storage
- GPIO: Supports 4 x GPI and 4 x GPO with TTL level (5V or 12V by

Block Diagram



Jumper)

Interface:

- On-board buzzer x1
- 9 x pins system header for Power LED/Power On/Reset/HDD LED
- 1 x 4-pin fan connector (For CPU); 1 x 3-pin fan connectors (For CPU or System)
- On-chip RTC with battery/CR2032 backup holder onboard

System Monitor

- 4 Voltages (+3.3V, +5V, +12V, Vcore)
- 2 Temperatures (For CPU and System)
- 3 FAN speed monitors (1 for CPU and 2 for Chassis Fan/System)

Power Input

- Support AT/ATX mode
- Standard ATX 24-pin connector for +12V/+5V/+3.3V/+5Vsb/-12V
- ATX 4-pin connector for +12V

Dimensions

- Micro ATX
- Dimension: Lx W, 244mm x 244mm; 9.6" x 9.6"

Environment

- Board level operating temperatures: 0°C to 60°C
- Storage temperature: -20°C to 85°C
- Relative humidity: 10% to 90%, (Non-condensing)

Certifications

- Meet CE
- Meet FCC

Ordering Information

♦ NEX 883-10PBK (P/N : 10G00088301X0)

Bulk-Packed 10 x pcs u-ATX, LGA1155 3rd/2nd Generation Intel® Core™ i7/i5/i3, Celeron processors, Q77 with 4 x DDR3/DIMM, HDMI/DP/DVI-I, PCIe16/PCIex4/2PCI/mPCIe, 2 x SATA3.0/2 x SATA 2.0, 4 x USB3.0/8 x USB2.0, 2GbE, 6COM, mSATA, ATX Power Input